

UNISONIC TECHNOLOGIES CO., LTD

UFP254 Power MOSFET

23A, 250V N-CHANNEL POWER MOSFET

■ DESCRIPTION

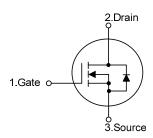
The UTC **UFP254** is an N-channel mode Power FET, it uses UTC's advanced technology. This technology allows a minimum on-state resistance, superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

1 TO-220F2

■ FEATURES

- * $R_{DS(ON)} \le 140 \text{m}\Omega$ @ $V_{GS}=10V$, $I_D=14A$
- * Low Gate Charge (Maximum 140nC)
- * High Switching Speed

■ SYMBOL

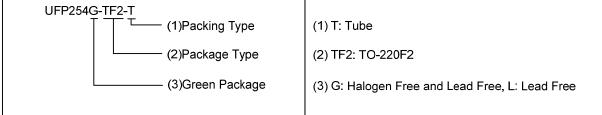


■ ORDERING INFORMATION

Ordering Number		Dookooo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UFP254L-TF2-T	UFP254G-TF2-T	TO-220F2	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source

UFP254G-TF2-T



MARKING



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ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	250	V	
Gate-Source Voltage	Source Voltage		±20	V	
Danie Oceanous	Continuous	I _D	23	Α	
Drain Current	Pulsed	I _{DM}	92	Α	
Avalanche Current		I _{AR}	23	Α	
Avalanche Energy	Single Pulsed	E _{AS}	1780	mJ	
Peak Diode Recovery dv/dt	Diode Recovery dv/dt		9	V/ns	
Power Dissipation		P _D	42	W	
Junction Temperature	ction Temperature		+150	°C	
Storage Temperature Range		T _{STG}	-55 ~ +150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT	
OFF CHARACTERISTICS		I OTNIBOL	TEST CONDITIONS	MIN	1 1 1 1	IVIZZZ	SINII	
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	250			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =250V			25	μA	
	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V	İ	<u> </u>	+100	nA	
Gate-Source Leakage Current	Reverse		V _{GS} =-20V, V _{DS} =0V	İ	<u> </u>	-100	nA	
ON CHARACTERISTICS		<u> </u>	, 55 =, 55 • -	ı	ı			
Gate Threshold Voltage		V _{GS(TH)}	I _D =250μA	2.0		4.0	V	
Static Drain-Source On-State Resi	istance	R _{DS(ON)}	V _{GS} =10V, I _D =14A			140	mΩ	
DYNAMIC PARAMETERS		20(0.17	, 50 , 5	ı	ı	l		
Input Capacitance		C _{ISS}			2800		pF	
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1MHz		380		pF	
Reverse Transfer Capacitance		C _{RSS}			23		pF	
SWITCHING PARAMETERS								
Total Gate Charge			\/ -E0\/ \/ -40\/ \ -4.0^4		120		nC	
Gate to Source Charge		Q_G Q_{GS}	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		19		nC	
Gate to Drain Charge		Q_{GD}	-I _G =100μA		21		nC	
Turn-ON Delay Time		t _{D(ON)}			85		ns	
Rise Time		t _R	V _{DD} =30V, V _{GS} =10V, I _D =0.5A,		115		ns	
Turn-OFF Delay Time		t _{D(OFF)}	$R_G=25\Omega$		780		ns	
Fall-Time		t _F			170		ns	
SOURCE- DRAIN DIODE RATING	GS AND CI	HARACTERIS	TICS	_		_		
Maximum Body-Diode Continuous	Current	Is				23	Α	
Maximum Body-Diode Pulsed Cur	rent	I _{SM}				92	Α	
Drain-Source Diode Forward Volta	ige	V_{SD}	I _S =23A, V _{GS} =0V			1.8	V	
Reverse Recovery Time		t _{rr}	V _{GS} = 0 V, I _S = 10A,		212		ns	
Reverse Recovery Charge		Q_{RR}	dI _F / dt = 100 A/μs (Note 1)		1.73		μC	
		C-NW	dl _F / dt = 100 A/µs (Note 1)	n				
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